

C0805X332KATACTU

Aliases (C0805X332KATAC7800)

SMD Comm X8G HT150C Flex, Ceramic, 3,300 pF, 10%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.6 mm



General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	11 mg
Shelf Life	78 Weeks
MSL	1

0805
2mm +/-0.3mm
1.25mm +/-0.3mm
0.78mm +/-0.20mm
0.6mm MIN
0.5mm +/-0.25mm

4000

Packaging Quantity

W	1.25mm +/-0.3mm	Tolerance	10%
Т	0.78mm +/-0.20mm	Voltage DC	250 VI
S	0.6mm MIN	Dielectric Withstanding Voltage	625 VE
В	0.5mm +/-0.25mm	Temperature Range	-55/+1
		Temp. Coefficient	X8G
Packaging Specifications		Capacitance Change with	30 ppr
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC	

Specifications	
Capacitance	3,300 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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